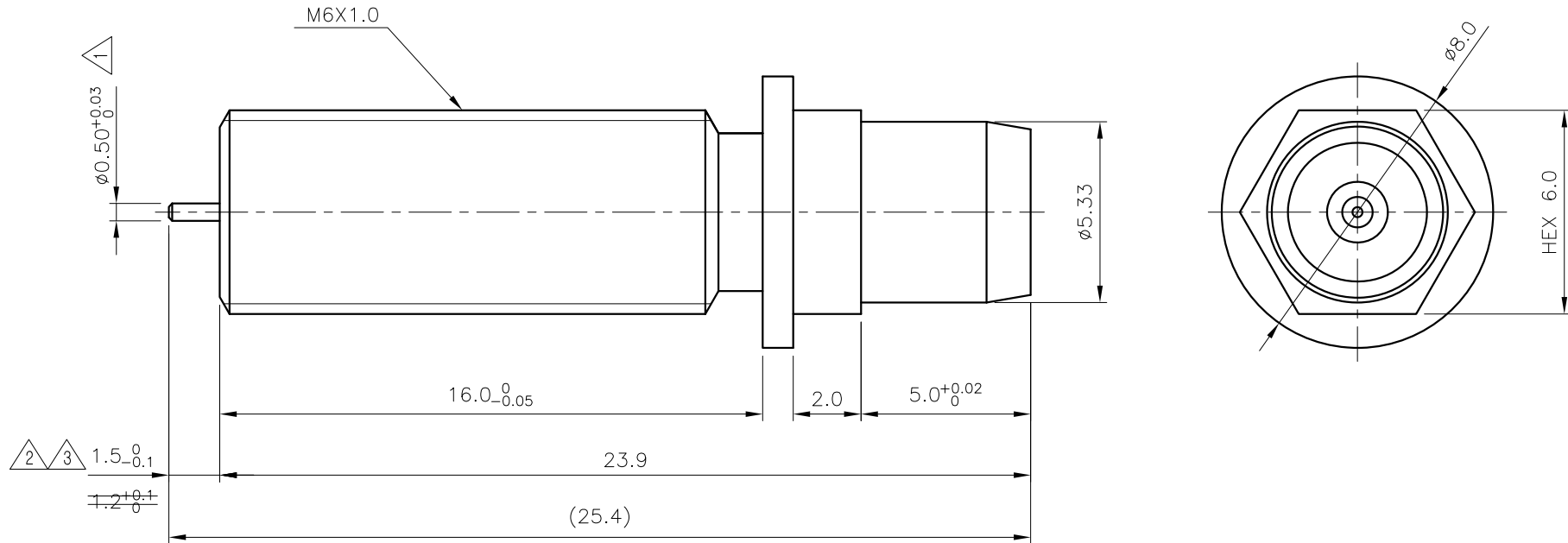


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	H.J.LEE	I.C.KIM	2015.12.11.
1	고객사 요청 부품 관리공차 변경	S.H.KIM		2022.11.01.
2	고객사 요청 부품 핀 길이 변경	S.H.KIM		2023.01.05.
3	[설번처리No.202402-0001] 고객사 요청 돌출 핀 길이 수정	S.H.KIM		2024.02.06.



Notes:

- 본 제품은 군수용으로 모든 사항을 MIL-SPEC.에 의거하여 제작할 것
- 1-1. BODY : ASTM
- 1-2. CONTACT : MIL-G-45204
- 1-3. INSULATOR : ASTM-D-1457

3	INSULATOR	1	TEFLON		DIN02702-N/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate (1.27μm)	DCT03611-5/2 DCT03611-5/1
1	BODY	1	SUS303	Passivated	DBD04092-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2024. 02. 06.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY			
MATERIAL _____	CHECKED BY			TITLE BMA50 SOLDER END PB(F/F)	
	DRAWN BY S.H.KIM				
FINISH _____	SCALE 5/1	UNIT mm		A4	DWG NO. CN03537-7/1
					REVISION 3 SHEET 1 of 1